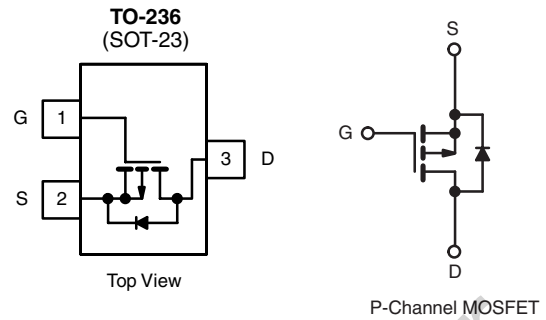


## FEATURES

- Isolated Package
- High Voltage Isolation = 2.5 kVRMS ( $t = 60$  s;  
 $f = 60$  Hz)
- Sink to Lead Creepage Distance = 4.8 mm
- P-Channel
- 175 °C Operating Temperature
- Dynamic dV/dt Rating
- Low Thermal Resistance
- Lead (Pb)-free Available



## PRODUCT SUMMARY

|                           |                   |      |
|---------------------------|-------------------|------|
| $V_{DS}$ (V)              | - 60              |      |
| $R_{DS(on)}$ ( $\Omega$ ) | $V_{GS} = - 10$ V | 0.40 |
| $Q_g$ (Max.) (nC)         | 12                |      |
| $Q_{gs}$ (nC)             | 3.8               |      |
| $Q_{gd}$ (nC)             | 5.1               |      |
| Configuration             | Single            |      |

## ABSOLUTE MAXIMUM RATINGS $T_C = 25$ °C, unless otherwise noted

| PARAMETER                                        |                                    |                                     | SYMBOL         | LIMIT            | UNIT                  |
|--------------------------------------------------|------------------------------------|-------------------------------------|----------------|------------------|-----------------------|
| Drain-Source Voltage                             |                                    |                                     | $V_{DS}$       | - 60             | V                     |
| Gate-Source Voltage                              |                                    |                                     | $V_{GS}$       | $\pm 20$         |                       |
| Continuous Drain Current                         | $V_{GS}$ at - 10 V                 | $T_C = 25\text{ }^{\circ}\text{C}$  | $I_D$          | - 5.2            | A                     |
|                                                  |                                    | $T_C = 100\text{ }^{\circ}\text{C}$ |                | - 3.8            |                       |
| Pulsed Drain Current <sup>a</sup>                |                                    |                                     | $I_{DM}$       | - 21             |                       |
| Linear Derating Factor                           |                                    |                                     |                | 0.18             | W/ $^{\circ}\text{C}$ |
| Single Pulse Avalanche Energy <sup>b</sup>       |                                    |                                     | $E_{AS}$       | 120              | mJ                    |
| Repetitive Avalanche Current <sup>a</sup>        |                                    |                                     | $I_{AR}$       | - 5.2            | A                     |
| Repetitive Avalanche Energy <sup>a</sup>         |                                    |                                     | $E_{AR}$       | 2.7              | mJ                    |
| Maximum Power Dissipation                        | $T_C = 25\text{ }^{\circ}\text{C}$ |                                     | $P_D$          | 27               | W                     |
| Peak Diode Recovery $dV/dt$ <sup>c</sup>         |                                    |                                     | $dV/dt$        | - 4.5            | V/ns                  |
| Operating Junction and Storage Temperature Range |                                    |                                     | $T_J, T_{stg}$ | - 55 to + 175    | $^{\circ}\text{C}$    |
| Soldering Recommendations (Peak Temperature)     | for 10 s                           |                                     |                | 300 <sup>d</sup> |                       |
| Mounting Torque                                  | 6-32 or M3 screw                   |                                     |                | 10               | lbf · in              |
|                                                  |                                    |                                     |                | 1.1              | N · m                 |

## Notes

- Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).
- $V_{DD} = - 25$  V, starting  $T_J = 25$  °C,  $L = 5.0$  mH,  $R_G = 25$   $\Omega$ ,  $I_{AS} = - 5.3$  A (see fig. 12).
- $I_{SD} \leq - 6.7$  A,  $dI/dt \leq 90$  A/ $\mu$ s,  $V_{DD} \leq V_{DS}$ ,  $T_J \leq 175$  °C.
- 1.6 mm from case.

| THERMAL RESISTANCE RATINGS       |            |      |      |                      |
|----------------------------------|------------|------|------|----------------------|
| PARAMETER                        | SYMBOL     | TYP. | MAX. | UNIT                 |
| Maximum Junction-to-Ambient      | $R_{thJA}$ | -    | 65   | $^{\circ}\text{C/W}$ |
| Maximum Junction-to-Case (Drain) | $R_{thJC}$ | -    | 5.5  |                      |

| SPECIFICATIONS $T_J = 25\text{ }^{\circ}\text{C}$ , unless otherwise noted |                     |                                                                                                                                         |                                                                                     |       |         |           |                             |
|----------------------------------------------------------------------------|---------------------|-----------------------------------------------------------------------------------------------------------------------------------------|-------------------------------------------------------------------------------------|-------|---------|-----------|-----------------------------|
| PARAMETER                                                                  | SYMBOL              | TEST CONDITIONS                                                                                                                         |                                                                                     | MIN.  | TYP.    | MAX.      | UNIT                        |
| Static                                                                     |                     |                                                                                                                                         |                                                                                     |       |         |           |                             |
| Drain-Source Breakdown Voltage                                             | $V_{DS}$            | $V_{GS} = 0\text{ V}$ , $I_D = -250\text{ }\mu\text{A}$                                                                                 |                                                                                     | - 60  | -       | -         | V                           |
| $V_{DS}$ Temperature Coefficient                                           | $\Delta V_{DS}/T_J$ | Reference to $25\text{ }^{\circ}\text{C}$ , $I_D = -1\text{ mA}$                                                                        |                                                                                     | -     | - 0.060 | -         | $\text{V}/^{\circ}\text{C}$ |
| Gate-Source Threshold Voltage                                              | $V_{GS(th)}$        | $V_{DS} = V_{GS}$ , $I_D = -250\text{ }\mu\text{A}$                                                                                     |                                                                                     | - 2.0 | -       | - 4.0     | V                           |
| Gate-Source Leakage                                                        | $I_{GSS}$           | $V_{GS} = \pm 20\text{ V}$                                                                                                              |                                                                                     | -     | -       | $\pm 100$ | nA                          |
| Zero Gate Voltage Drain Current                                            | $I_{DSS}$           | $V_{DS} = -60\text{ V}$ , $V_{GS} = 0\text{ V}$                                                                                         |                                                                                     | -     | -       | - 100     | $\mu\text{A}$               |
|                                                                            |                     | $V_{DS} = -48\text{ V}$ , $V_{GS} = 0\text{ V}$ , $T_J = 150\text{ }^{\circ}\text{C}$                                                   |                                                                                     | -     | -       | - 500     |                             |
| Drain-Source On-State Resistance                                           | $R_{DS(on)}$        | $V_{GS} = -10\text{ V}$                                                                                                                 | $I_D = -3.2\text{ A}^b$                                                             | -     | -       | 0.40      | $\Omega$                    |
| Forward Transconductance                                                   | $g_{fs}$            | $V_{DS} = -25\text{ V}$ , $I_D = -3.2\text{ A}^b$                                                                                       |                                                                                     | 1.6   | -       | -         | S                           |
| Dynamic                                                                    |                     |                                                                                                                                         |                                                                                     |       |         |           |                             |
| Input Capacitance                                                          | $C_{iss}$           | $V_{GS} = 0\text{ V}$ ,<br>$V_{DS} = -25\text{ V}$ ,<br>$f = 1.0\text{ MHz}$ , see fig. 5                                               |                                                                                     | -     | 270     | -         | pF                          |
| Output Capacitance                                                         | $C_{oss}$           |                                                                                                                                         |                                                                                     | -     | 170     | -         |                             |
| Reverse Transfer Capacitance                                               | $C_{rss}$           |                                                                                                                                         |                                                                                     | -     | 31      | -         |                             |
| Drain to Sink Capacitance                                                  | $C$                 | $f = 1.0\text{ MHz}$                                                                                                                    |                                                                                     | -     | 12      | -         |                             |
| Total Gate Charge                                                          | $Q_g$               | $V_{GS} = -10\text{ V}$                                                                                                                 | $I_D = -4.7\text{ A}$ , $V_{DS} = -48\text{ V}$ ,<br>see fig. 6 and 13 <sup>b</sup> | -     | -       | 12        | nC                          |
| Gate-Source Charge                                                         | $Q_{gs}$            |                                                                                                                                         |                                                                                     | -     | -       | 3.8       |                             |
| Gate-Drain Charge                                                          | $Q_{gd}$            |                                                                                                                                         |                                                                                     | -     | -       | 5.1       |                             |
| Turn-On Delay Time                                                         | $t_{d(on)}$         | $V_{DD} = -30\text{ V}$ , $I_D = -4.7\text{ A}$ ,<br>$R_G = 24\text{ }\Omega$ , $R_D = 4.0\text{ }\Omega$ ,<br>see fig. 10 <sup>b</sup> |                                                                                     | -     | 11      | -         | ns                          |
| Rise Time                                                                  | $t_r$               |                                                                                                                                         |                                                                                     | -     | 63      | -         |                             |
| Turn-Off Delay Time                                                        | $t_{d(off)}$        |                                                                                                                                         |                                                                                     | -     | 9.6     | -         |                             |
| Fall Time                                                                  | $t_f$               |                                                                                                                                         |                                                                                     | -     | 31      | -         |                             |
| Internal Drain Inductance                                                  | $L_D$               | Between lead,<br>6 mm (0.25") from<br>package and center of<br>die contact                                                              |                                                                                     | -     | 4.5     | -         | nH                          |
| Internal Source Inductance                                                 | $L_S$               |                                                                                                                                         |                                                                                     | -     | 7.5     | -         |                             |
| Drain-Source Body Diode Characteristics                                    |                     |                                                                                                                                         |                                                                                     |       |         |           |                             |
| Continuous Source-Drain Diode Current                                      | $I_S$               | MOSFET symbol<br>showing the<br>integral reverse<br>p - n junction diode                                                                |                                                                                     | -     | -       | - 5.2     | A                           |
| Pulsed Diode Forward Current <sup>a</sup>                                  | $I_{SM}$            |                                                                                                                                         |                                                                                     | -     | -       | - 21      |                             |
| Body Diode Voltage                                                         | $V_{SD}$            | $T_J = 25\text{ }^{\circ}\text{C}$ , $I_S = -5.2\text{ A}$ , $V_{GS} = 0\text{ V}^b$                                                    |                                                                                     | -     | -       | - 5.5     | V                           |
| Body Diode Reverse Recovery Time                                           | $t_{rr}$            | $T_J = 25\text{ }^{\circ}\text{C}$ , $I_F = -4.7\text{ A}$ , $dI/dt = 100\text{ A}/\mu\text{s}^b$                                       |                                                                                     | -     | 80      | 160       | ns                          |
| Body Diode Reverse Recovery Charge                                         | $Q_{rr}$            |                                                                                                                                         |                                                                                     | -     | 0.096   | 0.19      | $\mu\text{C}$               |
| Forward Turn-On Time                                                       | $t_{on}$            | Intrinsic turn-on time is negligible (turn-on is dominated by $L_S$ and $L_D$ )                                                         |                                                                                     |       |         |           |                             |

#### Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).  
b. Pulse width  $\leq 300\text{ }\mu\text{s}$ ; duty cycle  $\leq 2\%$ .

**TYPICAL CHARACTERISTICS** 25 °C, unless otherwise noted

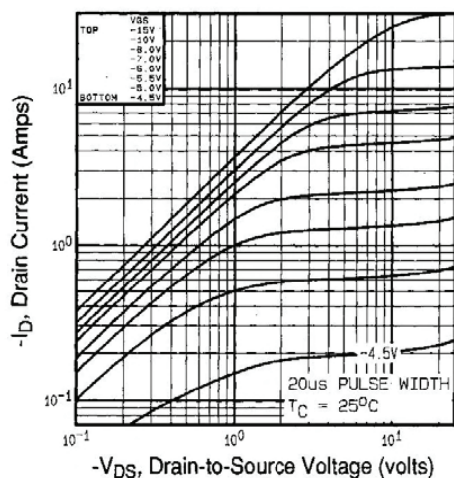


Fig. 1 - Typical Output Characteristics,  $T_C = 25^\circ\text{C}$

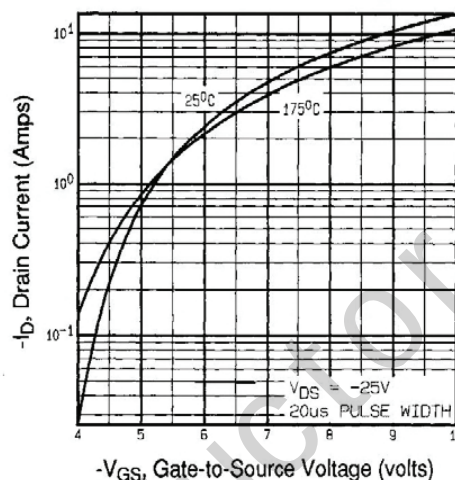


Fig. 3 - Typical Transfer Characteristics

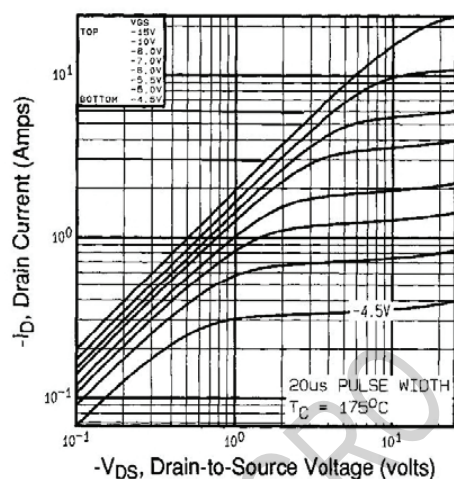


Fig. 2 - Typical Output Characteristics,  $T_C = 175^\circ\text{C}$

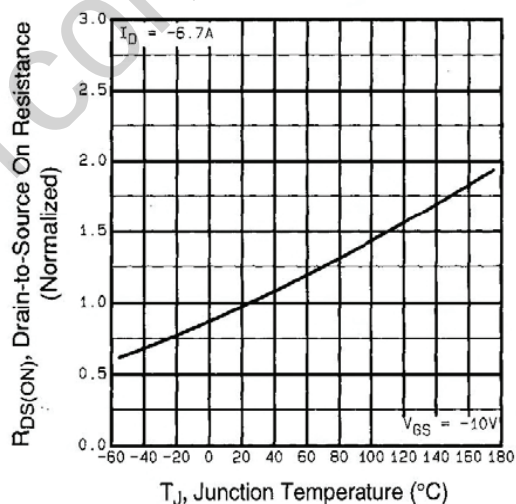


Fig. 4 - Normalized On-Resistance vs. Temperature

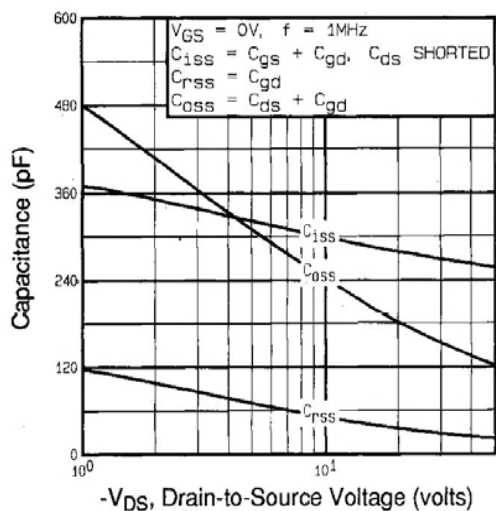


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

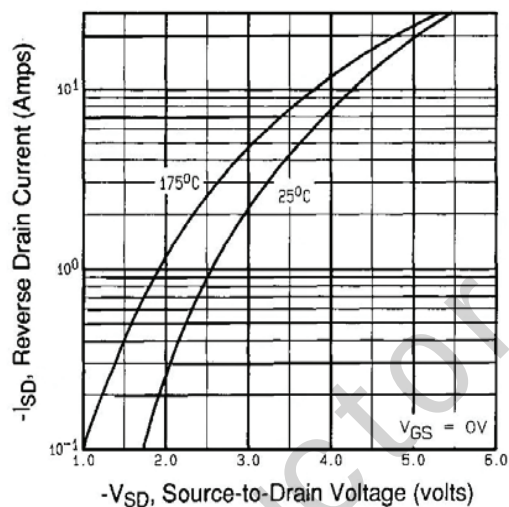


Fig. 7 - Typical Source-Drain Diode Forward Voltage

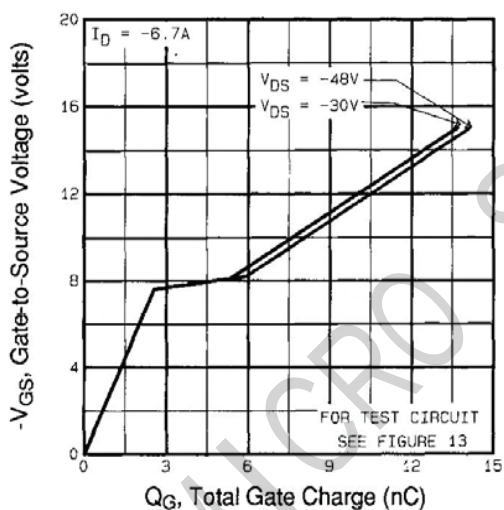


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

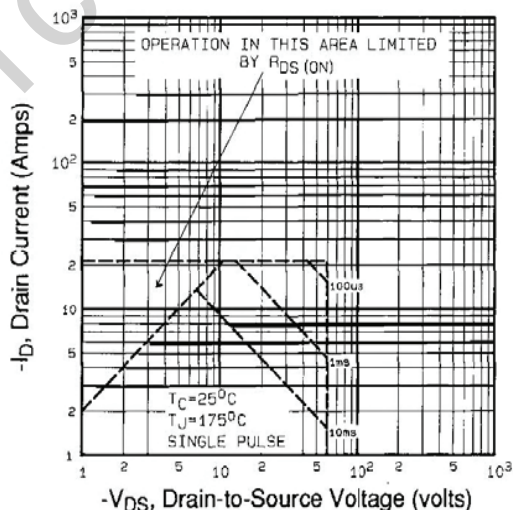


Fig. 8 - Maximum Safe Operating Area

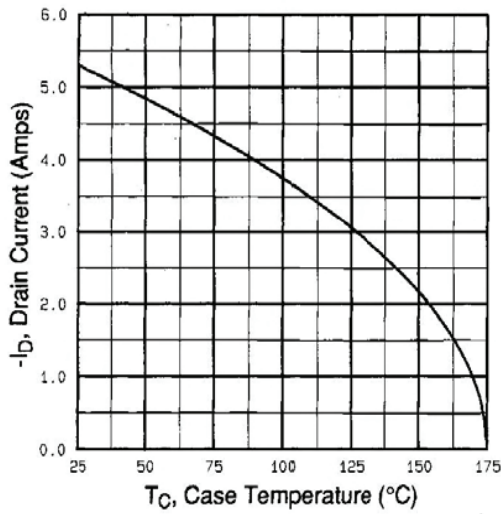


Fig. 9 - Maximum Drain Current vs. Case Temperature

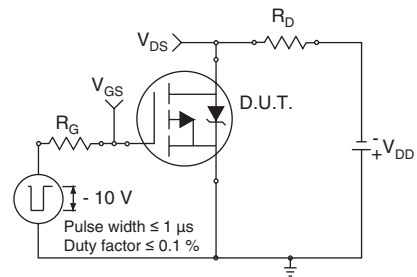


Fig. 10a - Switching Time Test Circuit

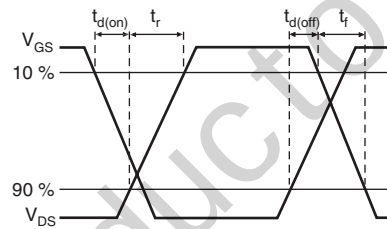


Fig. 10b - Switching Time Waveforms

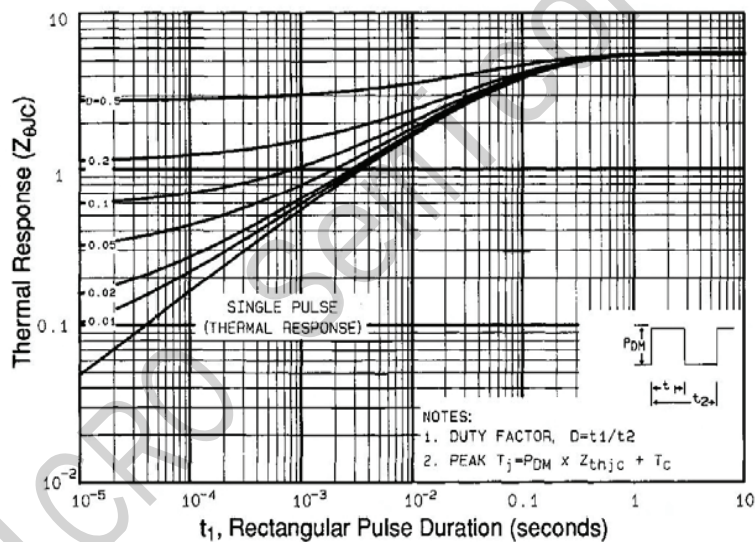


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case

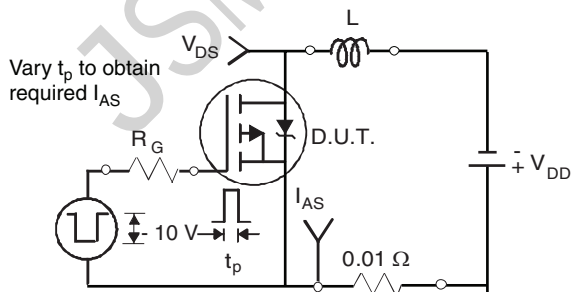


Fig. 12a - Unclamped Inductive Test Circuit

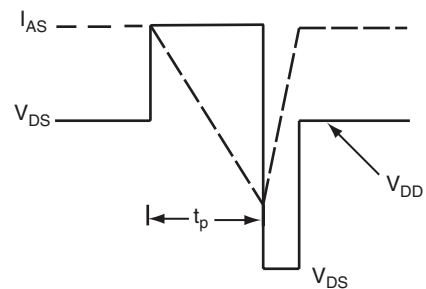


Fig. 12b - Unclamped Inductive Waveforms

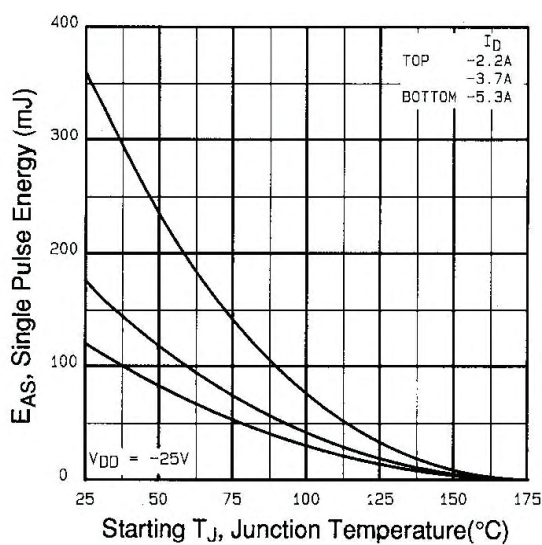


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

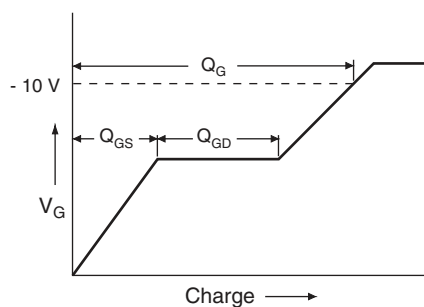


Fig. 13a - Basic Gate Charge Waveform

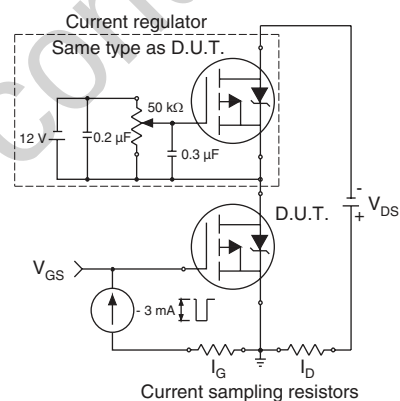


Fig. 13b - Gate Charge Test Circuit

**D.U.T.**

①

$R_G$

②

③

④

$V_{DD}$

• Compliment N-Channel of D.U.T. for driver

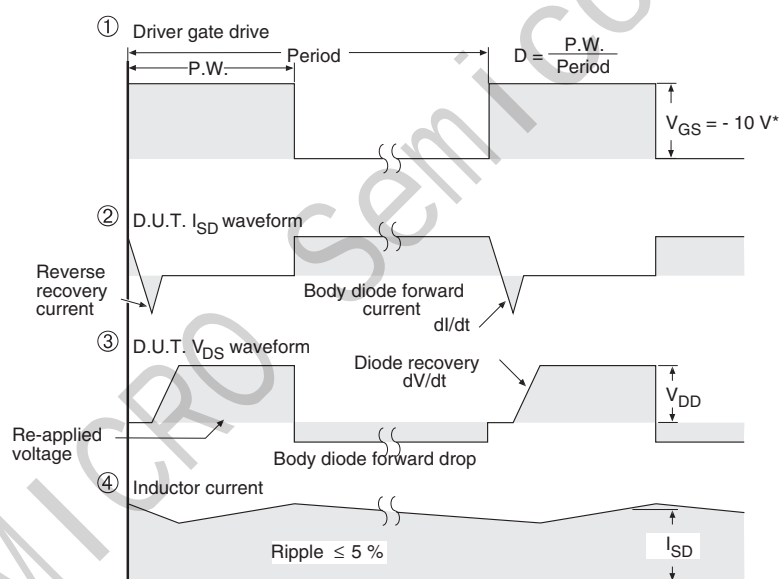
**Circuit layout considerations**

- Low stray inductance
- Ground plane
- Low leakage inductance current transformer

•  $dV/dt$  controlled by  $R_G$

•  $I_{SD}$  controlled by duty factor "D"

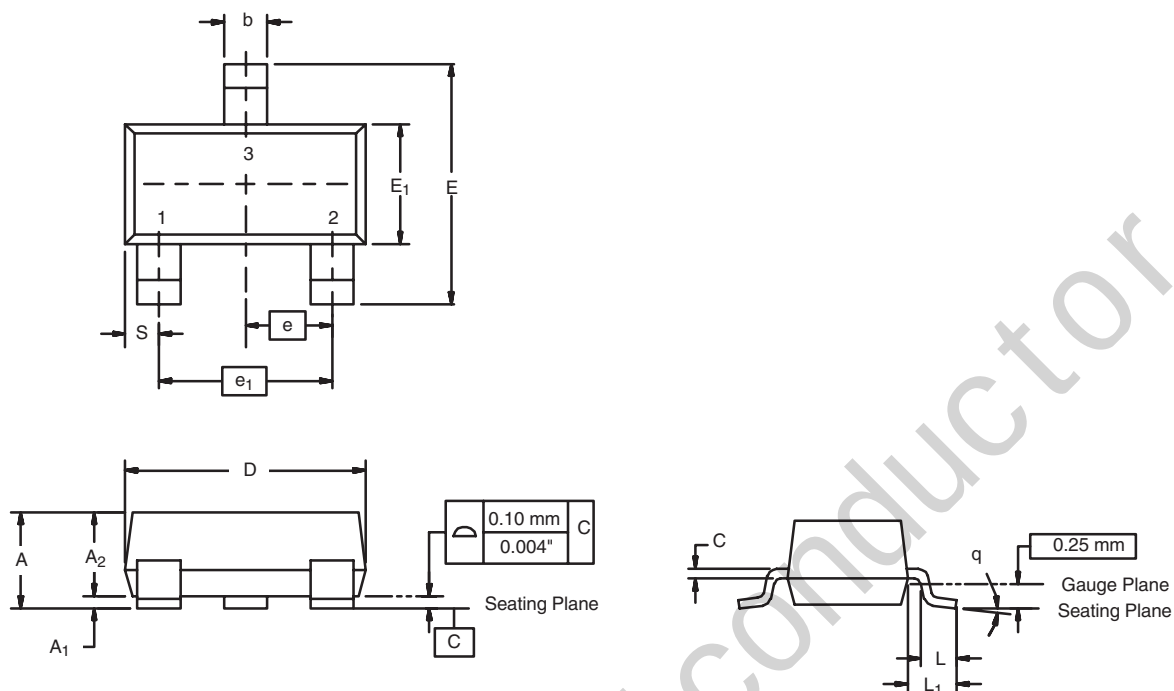
• D.U.T. - device under test



\*  $V_{GS} = -5\text{ V}$  for logic level and  $-3\text{ V}$  drive devices

**Fig. 14 - For P-Channel**

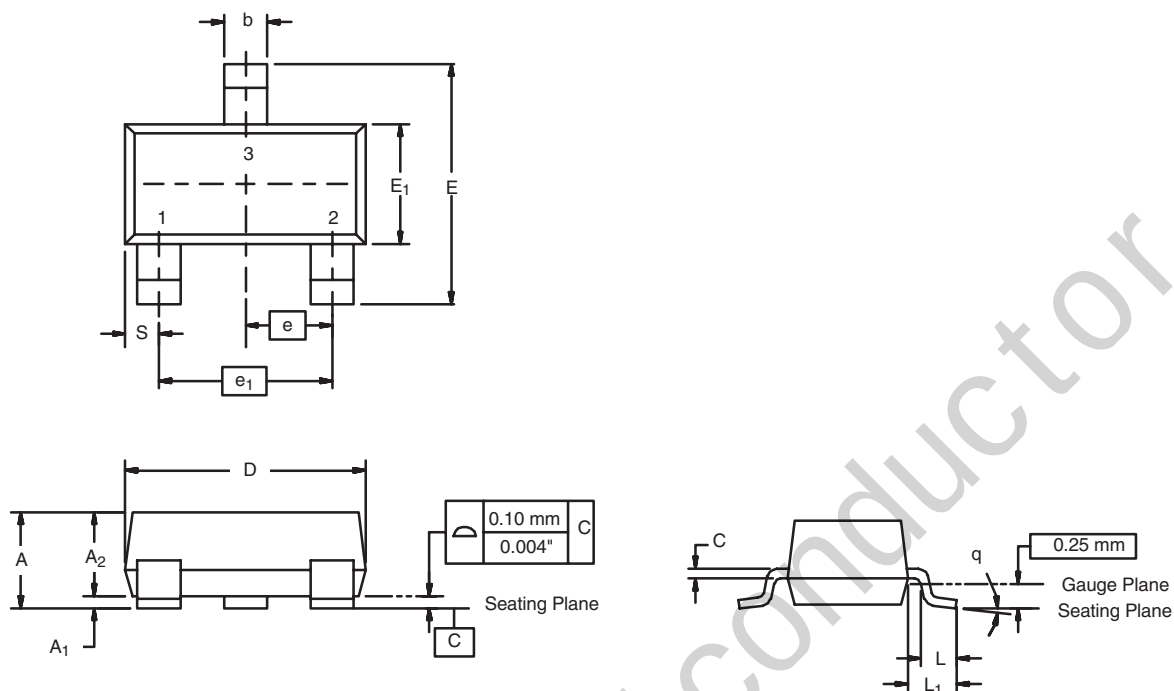
**SOT-23 (TO-236): 3-LEAD**



| Dim            | MILLIMETERS |      | INCHES     |       |
|----------------|-------------|------|------------|-------|
|                | Min         | Max  | Min        | Max   |
| A              | 0.89        | 1.12 | 0.035      | 0.044 |
| A <sub>1</sub> | 0.01        | 0.10 | 0.0004     | 0.004 |
| A <sub>2</sub> | 0.88        | 1.02 | 0.0346     | 0.040 |
| b              | 0.35        | 0.50 | 0.014      | 0.020 |
| c              | 0.085       | 0.18 | 0.003      | 0.007 |
| D              | 2.80        | 3.04 | 0.110      | 0.120 |
| E              | 2.10        | 2.64 | 0.083      | 0.104 |
| E <sub>1</sub> | 1.20        | 1.40 | 0.047      | 0.055 |
| e              | 0.95 BSC    |      | 0.0374 Ref |       |
| e <sub>1</sub> | 1.90 BSC    |      | 0.0748 Ref |       |
| L              | 0.40        | 0.60 | 0.016      | 0.024 |
| L <sub>1</sub> | 0.64 Ref    |      | 0.025 Ref  |       |
| S              | 0.50 Ref    |      | 0.020 Ref  |       |
| q              | 3°          | 8°   | 3°         | 8°    |

ECN: S-03946-Rev. K, 09-Jul-01  
DWG: 5479

**SOT-23 (TO-236): 3-LEAD**



| Dim                                         | MILLIMETERS |      | INCHES     |       |
|---------------------------------------------|-------------|------|------------|-------|
|                                             | Min         | Max  | Min        | Max   |
| A                                           | 0.89        | 1.12 | 0.035      | 0.044 |
| A <sub>1</sub>                              | 0.01        | 0.10 | 0.0004     | 0.004 |
| A <sub>2</sub>                              | 0.88        | 1.02 | 0.0346     | 0.040 |
| b                                           | 0.35        | 0.50 | 0.014      | 0.020 |
| c                                           | 0.085       | 0.18 | 0.003      | 0.007 |
| D                                           | 2.80        | 3.04 | 0.110      | 0.120 |
| E                                           | 2.10        | 2.64 | 0.083      | 0.104 |
| E <sub>1</sub>                              | 1.20        | 1.40 | 0.047      | 0.055 |
| e                                           | 0.95 BSC    |      | 0.0374 Ref |       |
| e <sub>1</sub>                              | 1.90 BSC    |      | 0.0748 Ref |       |
| L                                           | 0.40        | 0.60 | 0.016      | 0.024 |
| L <sub>1</sub>                              | 0.64 Ref    |      | 0.025 Ref  |       |
| S                                           | 0.50 Ref    |      | 0.020 Ref  |       |
| q                                           | 3°          | 8°   | 3°         | 8°    |
| ECN: S-03946-Rev. K, 09-Jul-01<br>DWG: 5479 |             |      |            |       |